

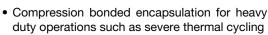
Phase Control Thyristors (Stud Version), 110 A



PRODUCT SUMMARY				
I _{T(AV)}	110 A			
V _{DRM} /V _{RRM}	400 V, 1600 V			
V_{TM}	1.52 V			
I _{GT}	150 mA			
T _J	-40 °C to 140 °C			
Package	TO-209AC (TO-94)			
Diode variation	Single SCR			

FEATURES

- · Center gate
- International standard case TO-209AC (TO-94)





- ROHS COMPLIAN
- Hermetic glass-metal case with ceramic insulator (Glass-metal seal over 1200 V)
- · Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see <u>www.vishav.com/doc?99912</u>

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		110	А			
I _{T(AV)}	T _C	90	°C			
I _{T(RMS)}		175				
1	50 Hz	2700	А			
I _{TSM}	60 Hz	2830				
I ² t	50 Hz	36.4	kA ² s			
I ^c t	60 Hz	33.2	KA-S			
V _{DRM} /V _{RRM}		400 to 1600	V			
tq	Typical	100	μs			
T _J		-40 to 125	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS									
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$\begin{split} I_{DRM}/I_{RRM} & \text{MAXIMUM AT} \\ T_J = T_J & \text{MAXIMUM} \\ & \text{mA} \end{split}$					
	04	400	500						
VC CT110C	08	800	900	20					
VS-ST110S	12	1200	1300	20					
	16	1600	1700						



ABSOLUTE MAXIMUM RATINGS	S					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average on-state current at case temperature	I _{T(AV)}	180° condu	ction, half sine	wave	110 90	A °C
Maximum RMS on-state current	I _{T(RMS)}	DC at 85 °C	case temperat	ure	175	- O
	. ()	t = 10 ms	No voltage		2700	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		2830	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		2270	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	2380	
Maximum I ² t for fusing		t = 10 ms	No voltage reapplied	initial $T_J = T_J$ maximum	36.4	
	l ² t	t = 8.3 ms			33.2	
		t = 10 ms	100 % V _{RRM}		25.8	
		t = 8.3 ms	reapplied		23.5	
Maximum I ² √t for fusing	I²√t	t = 0.1 to 10) ms, no voltage	e reapplied	364	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x \mid_{T(AV)} < I < \pi x$	$I_{T(AV)}$, $T_J = T_J$ maximum	0.90	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		0.92	V	
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum		1.79	mΩ	
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.81	11122	
Maximum on-state voltage	V_{TM}	$I_{pk} = 350 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$		1.52	V	
Maximum holding current	I _H	T _{.1} = 25 °C, anode supply 12 V resistive load		600	mA	
Typical latching current	IL			1000	111/4	

SWITCHING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum non-repetitive rate of rise of turned-on current	dI/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%~V_{DRM}$	500	A/μs	
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1 A/\mu s$ $V_d = 0.67 \% V_{DRM}, T_J = 25 °C$	2.0		
Typical turn-off time	t _q	I_{TM} = 100 A, T_J = T_J maximum, dl/dt = 10 A/μs, V_R = 50 V, dV/dt = 20 V/μs, gate 0 V 100 Ω , t_p = 500 μs	100	μs	

BLOCKING					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum critical rate of rise of off-state voltage	dV/dt	T _J = T _J maximum linear to 80 % rated V _{DRM}	500	V/µs	
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	20	mA	



TRIGGERING						
DADAMETER	SYMBOL	TE	TEST CONDITIONS		VALUES	
PARAMETER	SYMBOL	l Es	SI CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	P_{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	5		W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50		1	\ \ \ \
Maximum peak positive gate current	I _{GM}			2	.0	Α
Maximum peak positive gate voltage	+ V _{GM}	$T_J = T_J$ maximum,	$t_p \le 5 \text{ ms}$	20		V
Maximum peak negative gate voltage	- V _{GM}		5.0] V	
	l _{GT}	T _J = -40 °C	Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units 6 V anode to cathode applied	180	-	
DC gate current required to trigger		T _J = 25 °C		90	150	mA
		T _J = 125 °C		40	-	
		T _J = -40 °C		2.9	-	
DC gate voltage required to trigger	V_{GT}	T _J = 25 °C		1.8	3.0	V
		T _J = 125 °C		1.2	-	
DC gate current not to trigger	I _{GD}	T - T moving:	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	10		mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J \text{ maximum}$		0.25		V

THERMAL AND MECHANICAL SPECIFICATIONS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum operating junction temperature range	TJ		-40 to 125	°C	
Maximum storage temperature range	T _{Stg}		-40 to 150		
Maximum thermal resistance, junction to case	R _{thJC}	R _{thJC} DC operation		K/W	
Maximum thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth, flat and greased	0.08	10 00	
Mounting torque + 10 0/		Non-lubricated threads	15.5 (137)	Nm	
Mounting torque, ± 10 %		Lubricated threads	14 (120)	(lbf · in)	
Approximate weight			130	g	
Case style		See dimensions - link at the end of datasheet TO-209AC (TO		C (TO-94)	

△R _{thJC} CONDUCTION							
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS			
180°	0.035	0.025					
120°	0.041	0.042					
90°	0.052	0.056	$T_J = T_J$ maximum	K/W			
60°	0.076	0.079					
30°	0.126	0.127					

Note

• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

www.vishay.com

Vishay Semiconductors

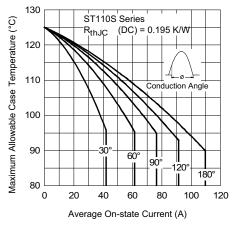


Fig. 1 - Current Ratings Characteristics

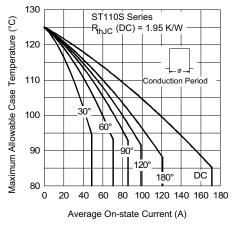


Fig. 2 - Current Ratings Characteristics

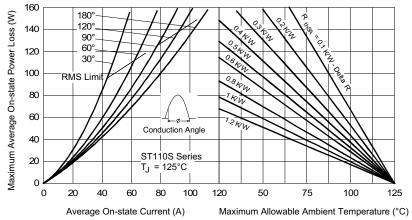


Fig. 3 - On-State Power Loss Characteristics

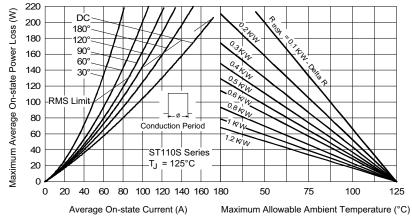


Fig. 4 - On-State Power Loss Characteristics



www.vishay.com

Vishay Semiconductors

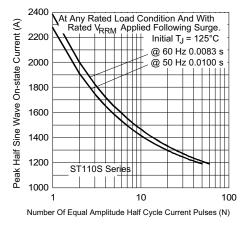


Fig. 5 - Maximum Non-Repetitive Surge Current

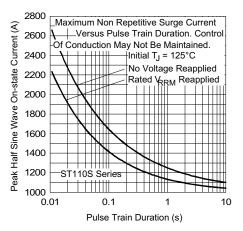


Fig. 6 - Maximum Non-Repetitive Surge Current

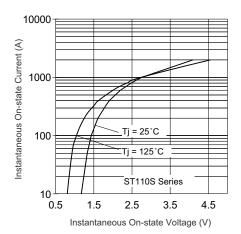


Fig. 7 - On-State Voltage Drop Characteristics

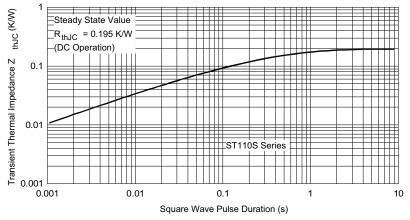


Fig. 8 - Thermal Impedance Z_{thJC} Characteristic

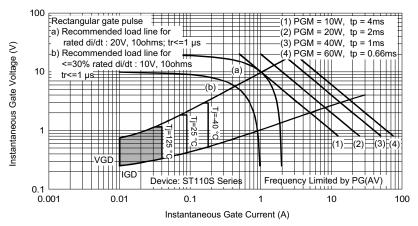
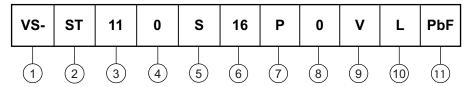


Fig. 9 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



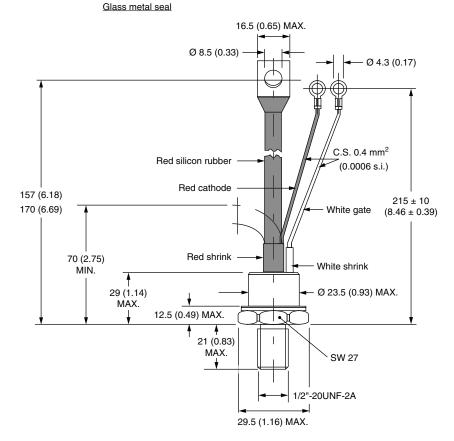
- 1 Vishay Semiconductors product
- 2 Thyristor
- 3 Essential part marking
- 4 0 = Converter grade
- 5 S = Compression bonding stud
- 6 Voltage code x 100 = V_{RRM} (see Voltage Ratings table)
- 7 P = Stud base 20UNF threads
- 8 0 = Eyelet terminals (gate and auxiliary cathode leads)
 - 1 = Fast-on terminals (gate and auxiliary cathode leads)
 - 2 = Flag terminals (for cathode and gate terminals)
- 9 • V = Glass-metal seal (only up to 1200 V)
 - None = Ceramic housing (over 1200 V)
- 10 Critical dV/dt:
 - None = 500 V/µs (standard value)
 - L = 1000 V/µs (special selection)
- 11 None = Standard production
 - PbF = Lead (Pb)-free

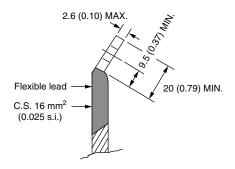
LINKS TO RELATED DOCUMENTS			
Dimensions	www.vishav.com/doc?95078		

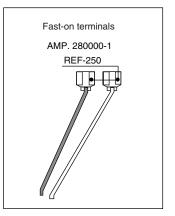


TO-209AC (TO-94) for ST110S Series

DIMENSIONS in millimeters (inches)







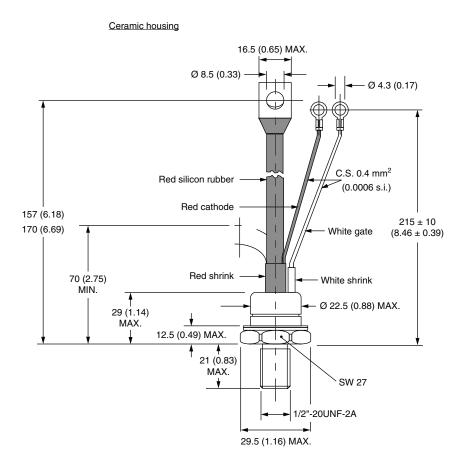
Outline Dimensions

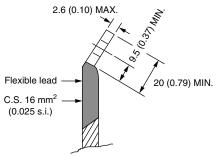
Vishay Semiconductors

TO-209AC (TO-94) for ST110S Series



DIMENSIONS in millimeters (inches)







Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.